NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
NOTES: (continued)

3. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

4. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
5. For alternate stencil design recommendations, see IPC-7525 or board assembly site preference.
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